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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6152071

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A SK HYNIX INC.		
2091, GYEONGCHUNG-DAERO, BUBAL-EUB, ICHEON-SI		
KOREA, REPUBLIC OF		
ent		

Total Attachments: 2

source=OPX19327-153US_Assignment Declaration#page1.tif source=OPX19327-153US_Assignment Declaration#page2.tif

This document serves as an Oath/Declaration (37 CFR 1.63).

ASSIGNMENT OF AND DECLARATION (37 CFR 1.63) FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS CHOI. Eun Ji et al, hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

IMPEDANCE CALIBRATION CIRCUIT AND SEMICONDUCTOR APPARATUS INCLUDING THE SAME

[X] said application being attached hereto;

[] said application having been filed in the United States Patent and Trademark Office on			
, as Application Serial No.	and	was	amended
on(if applicable);			
[] the specification of which was filed under the Patent Cooperation Treaty on			
Serial No, the United States of America being designated.			

AND WHEREAS SK hypix Inc.

hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof (i.e. divisional, continuation, and continuation-in-part applications), and in and to said invention and improvements ("invention") and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assigner, the receipt of which is hereby acknowledged, said assigner hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all patents which may be granted therefor, including any and all patents which may be granted therefor, including any and all patents which may be granted therefor, including any and all patents which may be granted therefor, including any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assignee, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignce, or said assignce's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (INVENTOR):

Signature:	CHOI	FUN	

Date: May 26, 2020

Printed or Typed Name: <u>CHOI, Eun Ji</u>

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최은지/Data&IF

		Attorney Docket No.:
Signature:	Hulang In Ha	Date: <u>May 26, 2020</u>
Printed or T	yped Name: <u>HWANG, Jin Ha</u>	
Signature:	AHN. Keun Seon	Date: <u>May 26, 2020</u>
Printed or 1	yped Name: <u>AHN, Keun Seon</u>	
Signature:	JEONG Y. Han	Date: <u>May 26, 2020</u>
Printed or T	yped Name: <u>JEONG, Yo Han</u>	



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